

#### **Features**

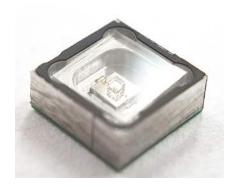
- 3535 UVC LED
- ROHS and REACH Compliant
- MSL 3 qualified according to J-STD 020
- ESD 8KV

## **Applications**

- Medical applications
- Industrial facility applications

### **Description**

The IN-C35PUDTDU1 is a low-power UVC LED. It is a SMD type LED which can be used in various applications.



**IN-C35PUDTDU1** 

#### **Recommended Solder Pattern**

(Suggest Stencil t=0.12 mm)

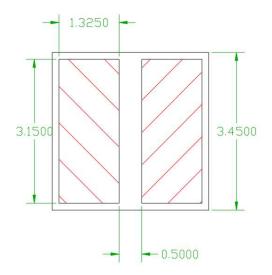


Figure 1. IN-C35PUDTDU1 Recommended Solder Pattern

#### Note:

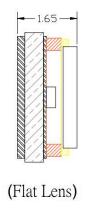
All dimensions are in millimeters.

Tolerance is ±0.13mm unless other specified.



# **Package Dimensions**

(All dimensions are in mm, tolerance is ±0.13mm)



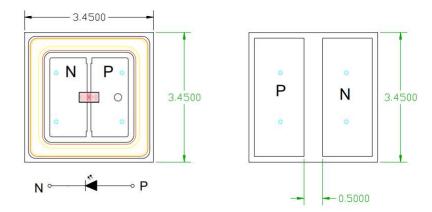


Figure 2. IN-C35PUDTDU1 Package Dimension



## Absolute Maximum Rating at 25°C

Characteristics	Symbol	Min.	Typical	Max.	Unit
DC Forward Current <sup>1</sup>	I <sub>F</sub>			20	mA
Forward Voltage	V <sub>F</sub>	5.5	6.5	8.0	V
Junction Temperature <sup>3</sup>	Tj		60		$^{\circ}\!\mathbb{C}$
Storage Temperature Range	$T_{stg}$	-40	-	80	$^{\circ}\!\mathbb{C}$
Operating Temperature	T <sub>opr</sub>	-10	-	50	
Soldering Temperature	T <sub>sol</sub>		245		$^{\circ}\!\mathbb{C}$
Thermal Resistance Junction / Solder Point	R <sub>th</sub>		55		°C/W
Viewing Angle <sup>4</sup>	2θ <sub>1/2</sub>		125		Deg

#### Notes:

- 1. For other ambient, limited setting of current will depend on de-rating curves.
- 2. When drive on maximum current, Tj must be kept below 65°C
- 3. Viewing angle( $2\theta 1/2$ ) ±  $10^{\circ}$

#### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

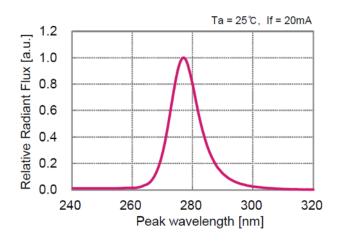
If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

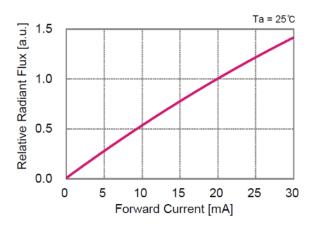


#### **Electronic-Optical Characteristics**

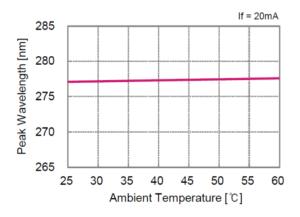
#### Relative Spectral Power Distribution



Relative Radiant Flux vs. Forward Current (Ta=25°C)

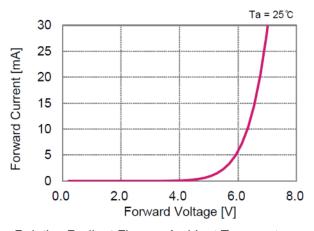


Relative Radiant Flux vs.Peak wavelength

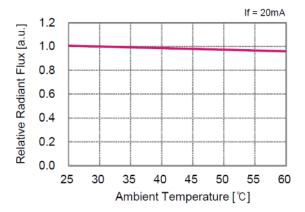


**Notes:** Viewing angle  $(2\theta 1/2) \pm 10^{\circ}$ 

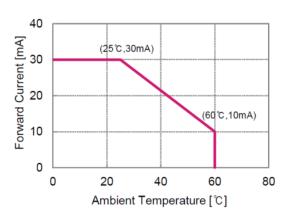
#### Forward Current vs. Forward Voltage (Ta=25°C)



Relative Radiant Flux vs. Ambient Temperature (IF=15mA)

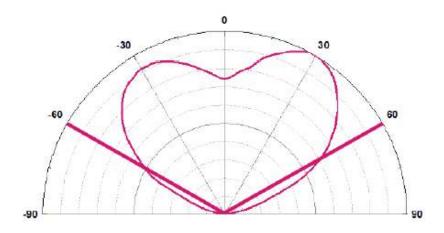


Derating





## **Typical Characteristic Curves – Radiation Pattern**



# **Ordering Information**

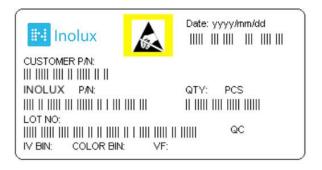
Peak Wavelength Range	Beam Angle	Forward	Forward Voltage(V)		
U1: 270~285nm		Min	Max		
	125°	5.5	8.0	IN-C35PUDTDU1	

#### Notes:

1. Forward voltage (VF )  $\pm 0.5$ V, Radiometric Power (Po)  $\pm 15$ %.



### **Label Specifications**



### **Inolux P/N:**

I	N	-	С	3	5	PUD	Т	D	U1	-	Х	Х	х	(
			Material	Pack	kage	Variation	Orientation	Current	Color				nized o-off	
	llux 1D		C = Ceramic Type	35PI	UD = 3.5 De <sub>i</sub>	5 x 3.5, 125 g.	T = Top Mount	D=20mA	U1 = 270- 285nm					

#### Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019 \	Month	Dato	Serial	
Tracker		Year (2017, 2018,)				Date	Serial



# **Forward Voltage Binning**

Voltage unit: V@20mA						
Peak Wavelength	Bin Code	Min	Max			
U1	А	5.5	6.6			
270nm-285nm	В	6.5	8.0			

#### Notes:

1. Binning current is 20 mA

# Radiant flux (Power) binning

Bin Code	Min. Po	Typ. Po	Max. Po
(20mA)	(mW)	(mW)	(mW)
P1	1.5	-	3.0

#### Notes:

1. Binning current is 20mA

# Peak wavelength binning reference table

Bin code (20mA)	Min. Wp (nm)	Max. Wp (nm)
W280	270.0	285.0

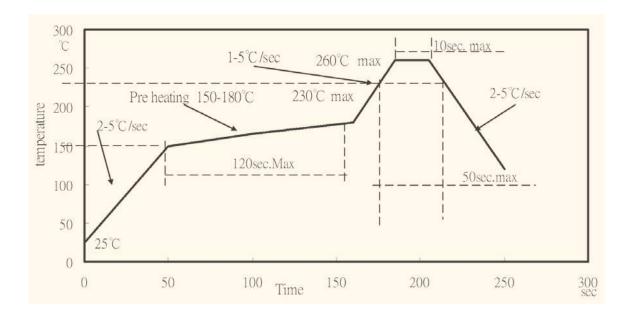
#### Notes:

1. Peak-wavelength (Wp) tolerance:  $\pm$  2.0nm

2. Testing Current 20mA



## **Reflow Soldering**



## **Soldering Iron**

Basic Spec is  $\leq$  4 sec. when 260°C (+10°C  $\rightarrow$  -1 second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

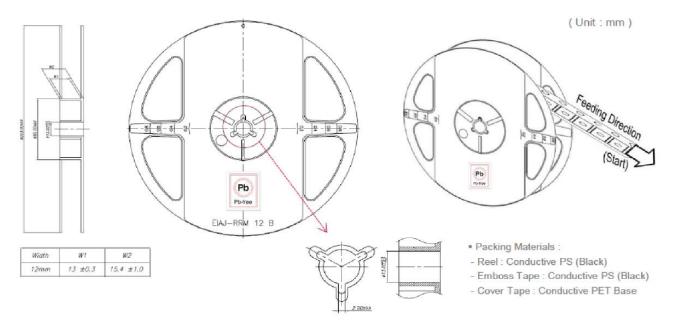
### **Rework**

Rework should be completed within 4 second under 245°C

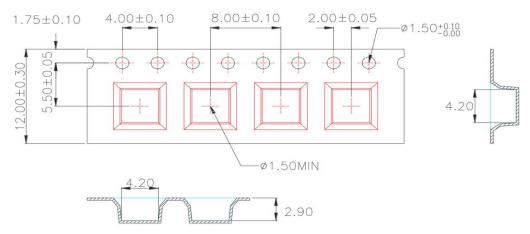


# **Packing**

#### Reel



## **Tape**



- 1. 10 sprocket hole pitch cumulative tolerance  $\pm 0.20$ .
- Carrier camber is within 1 mm in 250 mm.
   Material: Black Conductive Polystyrene Alloy.
- Material: Black Conductive Polystyrene Alloy.
   All dimensions meet EIA-481-D requirements.
   Thickness: 0.30±0.05mm.
   Packing length per 22 " reel: 62.5 Meters(1:3).
   Component load per 13" reel: 2500 pcs.

#### Notes:

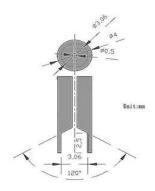
- 1. Each Reel (minimum number of pieces is 100 and maximum is 1000 (125D) is packed in a moistureproof bag along with 2 packs of desiccant and a humidity indicator card.
- 2. Part No., Lot No., quantity should be indicated on the label of the moisture-proof bag and the cardboard box.



#### **Precautions**

- 1. Recommendation for using LEDs
  - 1.1 The lens of LEDs should not be exposed to dust or debris. Excessive dust and debris may cause a drastic decrease in the luminosity.
  - 1.2 Avoid mechanical stress on LED lens.
  - 1.3 Do not touch the LED lens surface. It would affect the optical performance of the LED due to the LED lens' damage.
  - 1.4 Pick & place tools are recommended for the remove of LEDs from the factory tape & reel packaging
- 2. Pick & place nozzle

The pickup tool was recommended and shown as below



#### 3. Lens handling

Please follow the guideline to pick LEDs

- 3.1 Use tweezers to pick LEDs
- 3.2 Do not touch the lens by using tweezers
- 3.3 Do not touch lens with fingers
- 3.4 Do not apply more than 4N of lens (400g) directly onto the lens

#### 4. Lens cleaning

In the case which a small amount of dirt and dust particles remain on the lens surface, a suitable cleaning solution can be applied.

- 4.1 Try a gentle wiping with dust-free cloth
- 4.2 If needed, use dust-free cloth and isopropyl alcohol to gently clean the dirt from the lens surface.
- 4.3 Do not use other solvents as they may directly react with the LED assembly
- 4.4 Do not use ultrasonic cleaning which will damage the LEDs



# **Test Items and Results of Reliability**

Test Item	Test Conditions	Duration/ Cycle	Number of Damage	Reference
Thermal Shock	-40°C 30min ↑↓5min 125°C 30min	100 cycles	0/22	AECQ101
High Temperature Storage	Ta=100°C	500 hrs	0/22	EIAJ ED-4701 200 201
Humidity Heat Storage	Ta=85°ℂ RH=85%	500 hrs	0/22	EIAJ ED-4701 100 103
Low Temperature Storage	Ta=-40°C	500 hrs	0/22	EIAJ ED-4701 200 202
Life Test	Ta=25°ℂ If=15mA	500 hrs	0/22	Tested with IN standard
High Humidity Heat Life Test	85°C RH=85% If=15mA	500 hrs	0/22	Tested with IN standard
High Temperature Life Test	Ta=85 <sup>°</sup> C	500 hrs	0/22	Tested with IN standard
ESD(HBM)	8KV at 1.5kΩ;100pf	3 Times	0/22	MIL-STD-883

Criteria for Judging the Damage							
11	C. salasi	Criteria for Judgment					
Item	Symbol	Condition	Min	Max			
Forward Voltage	VF	If=15mA	LSL ×0.9	USL ×1.1			
Reverse Current	IR	VR =5V	_	100μΑ			
Luminous Intensity	lv	If=500mA	LSL ×0.7	USL ×1.2			

#### Notes:

1. USL: Upper specification level

2. LSL: Lower specification level



# **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	10-08-2020
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